

## Features

- **Low-power consumption**
  - Active: 25mA at 70ns
  - Stand-by: 10  $\mu$ A (CMOS input/output)  
2  $\mu$ A CMOS input/output, L version
- **Single + 1.8 to 2.2V Power Supply**
- **Equal access and cycle time**
- **70/85/100/150 ns access time**
- **Easy memory expansion with  $\overline{CE1}$ , CE2 and  $\overline{OE}$  inputs**
- **1.0V data retention mode**
- **TTL compatible, Tri-state input/output**
- **Automatic power-down when deselected**
- **Package available: 32-TSOP1 / STSOP**

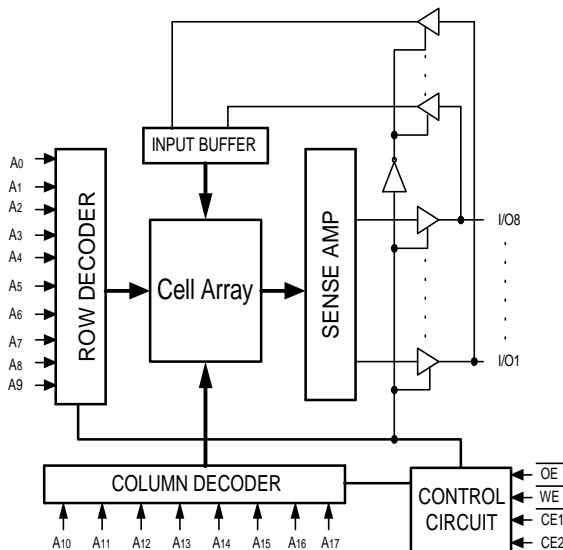
## Functional Description

The V62C1802048L is a low power CMOS Static RAM organized as 262,144 words by 8 bits. Easy memory expansion is provided by an active LOW  $\overline{CE1}$ , an active HIGH CE2, an active LOW  $\overline{OE}$ , and Tri-state I/O's. This device has an automatic power-down mode feature when deselected.

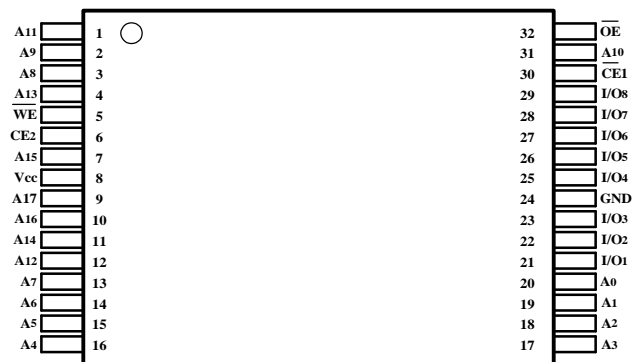
Writing to the device is accomplished by taking Chip Enable 1 ( $\overline{CE1}$ ) with Write Enable ( $\overline{WE}$ ) LOW, and Chip Enable 2 (CE2) HIGH. Reading from the device is performed by taking Chip Enable 1 ( $\overline{CE1}$ ) with Output Enable ( $\overline{OE}$ ) LOW while Write Enable ( $\overline{WE}$ ) and Chip Enable 2 (CE2) is HIGH. The I/O pins are placed in a high-impedance state when the device is deselected: the outputs are disabled during a write cycle.

The V62C1802048LL comes with a 1V data retention feature and Lower Standby Power. The V62C1802048L is available in a 32-pin 8 x 13.4 & 8 x 20 mm TSOP1 / STSOP packages.

## Logic Block Diagram



## 32-Pin TSOP1 / STSOP



**Absolute Maximum Ratings \***

Parameter	Symbol	Minimum	Maximum	Unit
Voltage on Any Pin Relative to Gnd	Vt	-0.5	4.6	V
Power Dissipation	P <sub>T</sub>	–	1.0	W
Storage Temperature (Plastic)	Tstg	-55	+150	°C
Temperature Under Bias	Tbias	-40	+85	°C

\* **Note:** Stresses greater than those listed above Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any conditions outside those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

**Truth Table**

CE1	CE2	WE	OE	Data	Mode
H	X	X	X	High-Z	Standby
X	L	X	X	High-Z	Standby
L	H	H	L	Data Out	Active, Read
L	H	H	H	High-Z	Active, Output Disable
L	H	L	X	Data In	Active, Write

\* **Key:** X = Don't Care, L = Low, H = High

**Recommended Operating Conditions (T<sub>A</sub> = 0°C to +70°C / -40°C to 85°C\*\*)**

Parameter	Symbol	Min	Typ	Max	Unit
Supply Voltage	V <sub>CC</sub>	1.8	2.0	2.2	V
	Gnd	0.0	0.0	0.0	V
Input Voltage	V <sub>IH</sub>	1.6	-	V <sub>CC</sub> + 0.2	V
	V <sub>IL</sub>	-0.5*	-	0.4	V

\* V<sub>IL</sub> min = -1.0V for pulse width less than t<sub>RC</sub>/2.

\*\* For Industrial Temperature.

**DC Operating Characteristics** ( $V_{CC} = 1.8$  to  $2.2V$ ,  $Gnd = 0V$ ,  $T_A = 0^{\circ}C$  to  $+70^{\circ}C$  /  $-40^{\circ}C$  to  $85^{\circ}C$ )

Parameter	Sym	Test Conditions	-70		-85		-100		-150		Unit
			Min	Max	Min	Max	Min	Max	Min	Max	
Input Leakage Current	$ I_{LI} $	$V_{CC} = Max,$ $V_{in} = Gnd$ to $V_{CC}$	-	1	-	1	-	1	-	1	$\mu A$
Output Leakage Current	$ I_{LO} $	$\overline{CE1} = V_{IH}$ or $CE2 = V_{IL}$ $V_{CC} = Max, V_{OUT} = Gnd$ to $V_{CC}$	-	1	-	1	-	1	-	1	$\mu A$
Operating Power Supply Current	$I_{CC}$	$\overline{CE1} = V_{IL}, CE2 = V_{IH}$ $V_{IN} = V_{IH}$ or $V_{IL}, I_{OUT} = 0mA$	-	3	-	3	-	3	-	3	mA
Average Operating Current	$I_{CC1}$	$\overline{CE1} = V_{IL}, CE2 = V_{IH}$ $I_{OUT} = 0mA,$ Min Cycle, 100% Duty	-	20	-	20	-	15	-	15	mA
	$I_{CC2}$	$\overline{CE1} = 0.2V,$ $CE2 = V_{CC} - 0.2V$ $I_{OUT} = 0mA,$ Cycle Time = $1\mu s$ , 100% Duty	-	3	-	3	-	3	-	3	mA
Standby Power Supply Current (TTL Level)	$I_{SB}$	$\overline{CE1} = V_{IH}$ or $CE2 = V_{IL}$	-	0.3	-	0.3	-	0.3	-	0.3	mA
Standby Power Supply Current (CMOS Level)	$I_{SB1}$	$\overline{CE1} \geq V_{CC} - 0.2V$ or $CE2 \leq 0.2V, f = 0$ $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$	-	10	-	10	-	10	-	10	$\mu A$
		<b>L</b>	-	2	-	2	-	2	-	2	$\mu A$
Output Low Voltage	$V_{OL}$	$I_{OL} = 2 mA$	-	0.4	-	0.4	-	0.4	-	0.4	V
Output High Voltage	$V_{OH}$	$I_{OH} = -1 mA$	1.6	-	1.6	-	1.6	-	1.6	-	V

**Capacitance** ( $f = 1MHz, T_A = 25^{\circ}C$ )

Parameter*	Symbol	Test Condition	Max	Unit
Input Capacitance	$C_{in}$	$V_{in} = 0V$	7	pF
I/O Capacitance	$C_{I/O}$	$V_{in} = V_{out} = 0V$	8	pF

\* This parameter is guaranteed by device characterization and is not production tested.

**AC Test Conditions**

Input Pulse Level                    0.4V to 1.6V  
 Input Rise and Fall Time         5ns  
 Input and Output Timing  
 Reference Level                     50% of input level  
     ( $V_{IL} + V_{IH}$ )/2

**Output Load Condition**

70ns/85 ns                     $C_L = 30pf + 1TTL$  Load  
 Load 100ns/150 ns         $C_L = 100pf + 1TTL$  Load

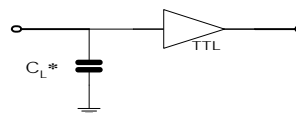


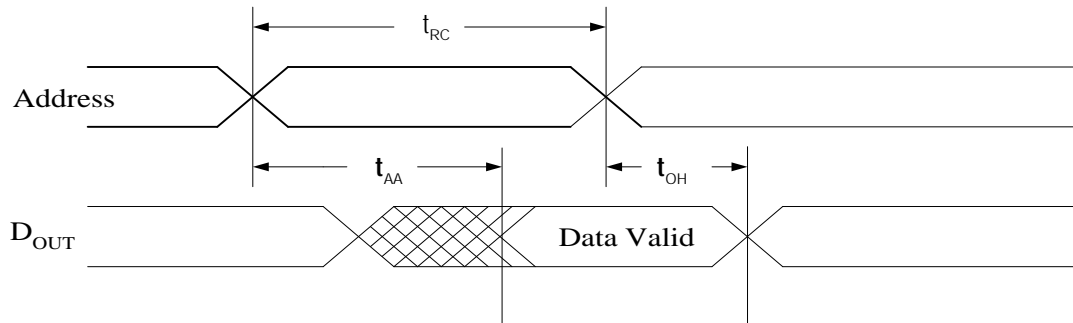
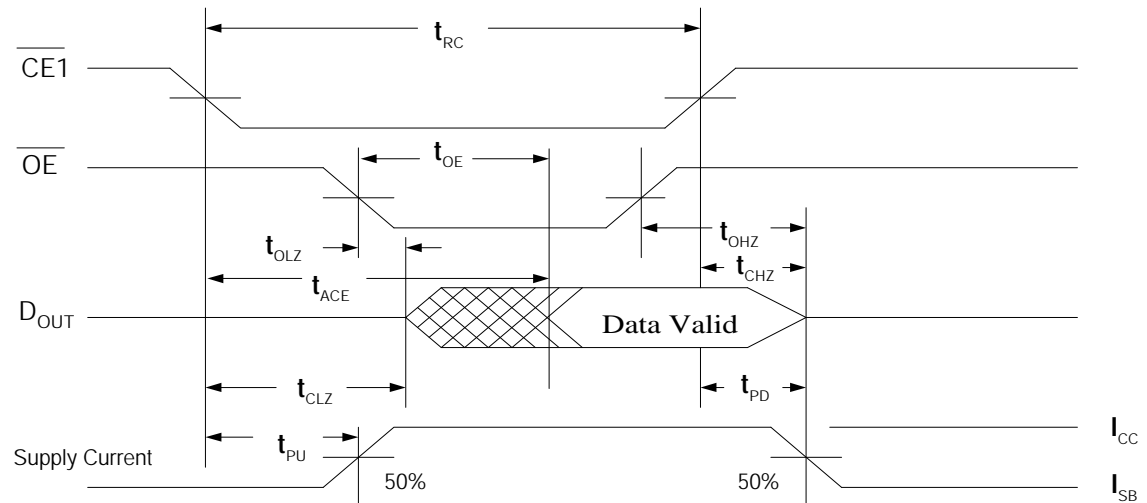
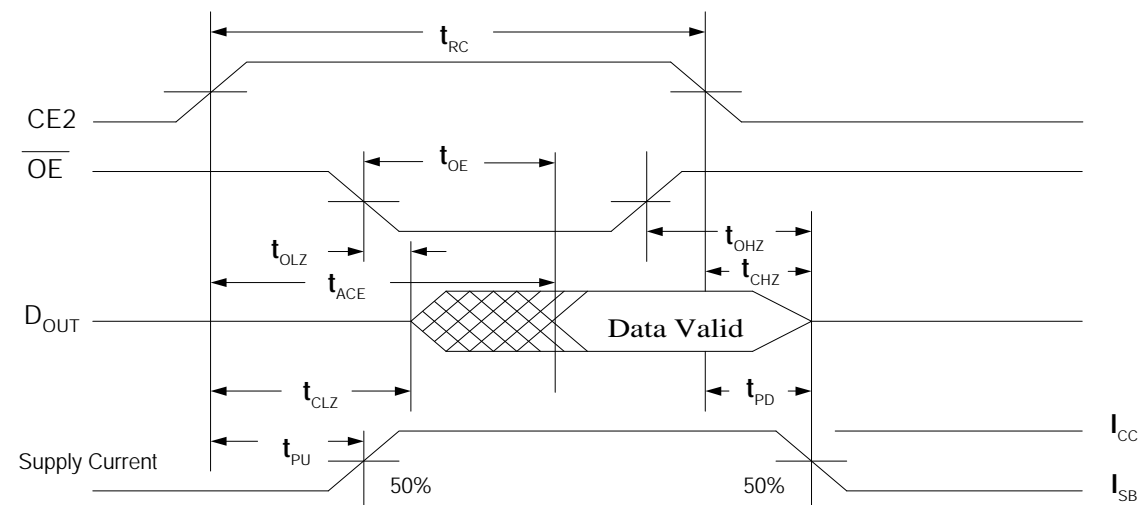
Figure A. \* Including Scope and Jig Capacitance

**Read Cycle** <sup>(3,9)</sup> ( $V_{cc} = 1.8$  to  $2.2V$ ,  $Gnd = 0V$ ,  $T_A = 0^{\circ}C$  to  $+70^{\circ}C$  /  $-40^{\circ}C$  to  $+85^{\circ}C$ )

Parameter	Symbol	-70		-85		-100		-150		Unit	Note
		Min	Max	Min	Max	Min	Max	Min	Max		
Read Cycle Time	$t_{RC}$	70	-	85	-	100	-	150	-	ns	
Address Access Time	$t_{AA}$	-	70	-	85	-	100	-	150	ns	
Chip Enable Access Time	$t_{ACE}$	-	70	-	85	-	100	-	150	ns	
Output Enable Access Time	$t_{OE}$	-	40	-	40	-	50	-	70	ns	
Output Hold from Address Change	$t_{OH}$	10	-	10	-	10	-	10	-	ns	
Chip Enable to Output in Low-Z	$t_{CLZ}$	10	-	10	-	10	-	10	-	ns	4,5
Chip Disable to Output in High-Z	$t_{CHZ}$	-	30	-	35	-	40	-	50	ns	4,5
Output Enable to Output in Low-Z	$t_{OLZ}$	5	-	5	-	5	-	5	-	ns	4,5
Output Disable to Output in High-Z	$t_{OHZ}$	-	25	-	30	-	35	-	40	ns	4,5
Power-Up Time	$t_{PU}$	0	-	0	-	0	-	0	-	ns	5
Power-Down Time	$t_{PD}$	-	70	-	85	-	100	-	150	ns	5

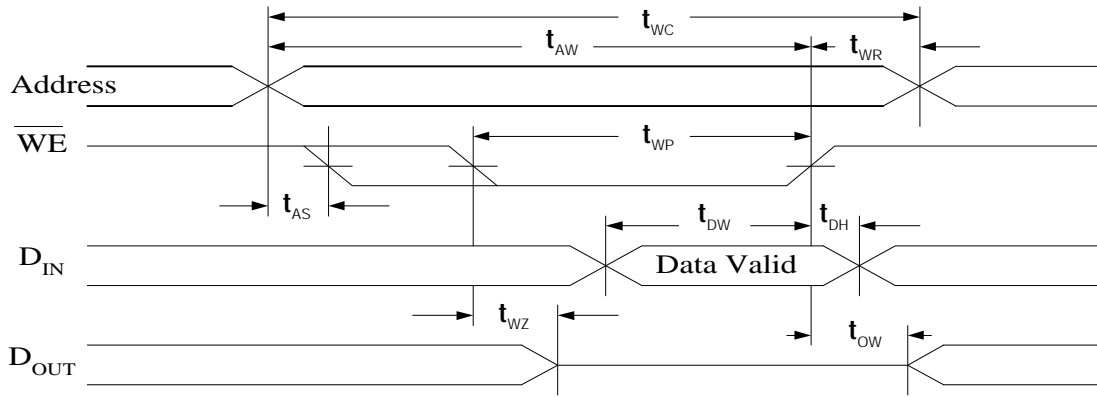
**Write Cycle** <sup>(3,11)</sup> ( $V_{cc} = 1.8$  to  $2.2V$ ,  $Gnd = 0V$ ,  $T_A = 0^{\circ}C$  to  $+70^{\circ}C$  /  $-40^{\circ}C$  to  $+85^{\circ}C$ )

Parameter	Symbol	-70		-85		-100		-150		Unit	Note
		Min	Max	Min	Max	Min	Max	Min	Max		
Write Cycle Time	$t_{WC}$	70	-	85	-	100	-	150	-	ns	
Chip Enable to Write End	$t_{CW}$	60	-	70	-	80	-	120	-	ns	
Address Setup to Write End	$t_{AW}$	60	-	70	-	80	-	120	-	ns	
Address Setup Time	$t_{AS}$	0	-	0	-	0	-	0	-	ns	
Write Pulse Width	$t_{WP}$	50	-	60	-	70	-	100	-	ns	
Write Recovering Time	$t_{WR}$	0	-	0	-	0	-	0	-	ns	
Data Valid to Write End	$t_{DW}$	30	-	35	-	40	-	60	-	ns	
Data Hold Time	$t_{DH}$	0	-	0	-	0	-	0	-	ns	
Write Enable to Output in High-Z	$t_{WZ}$	-	30	-	35	-	40	-	50	ns	4,5
Output Active from Write End	$t_{OW}$	5	-	5	-	5	-	5	-	ns	4,5

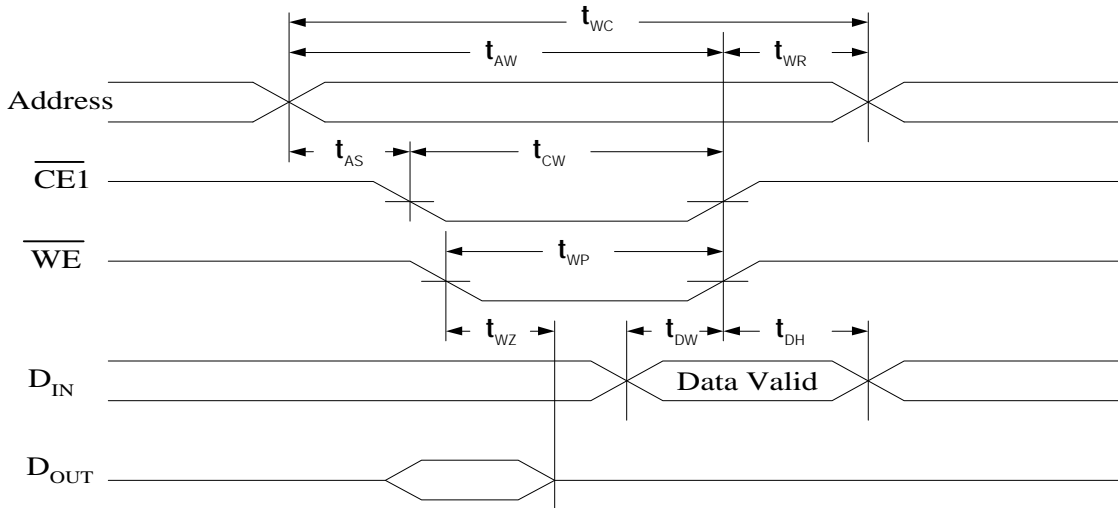
**Timing Waveform of Read Cycle 1<sup>(3,6,7,9)</sup> (Address Controlled)**

**Timing Waveform of Read Cycle 2<sup>(5,6,8,9)</sup> ( $\overline{CE1}$  Controlled)**

**Timing Waveform of Read Cycle 3<sup>(3,6,8,9)</sup> (CE2 Controlled)**




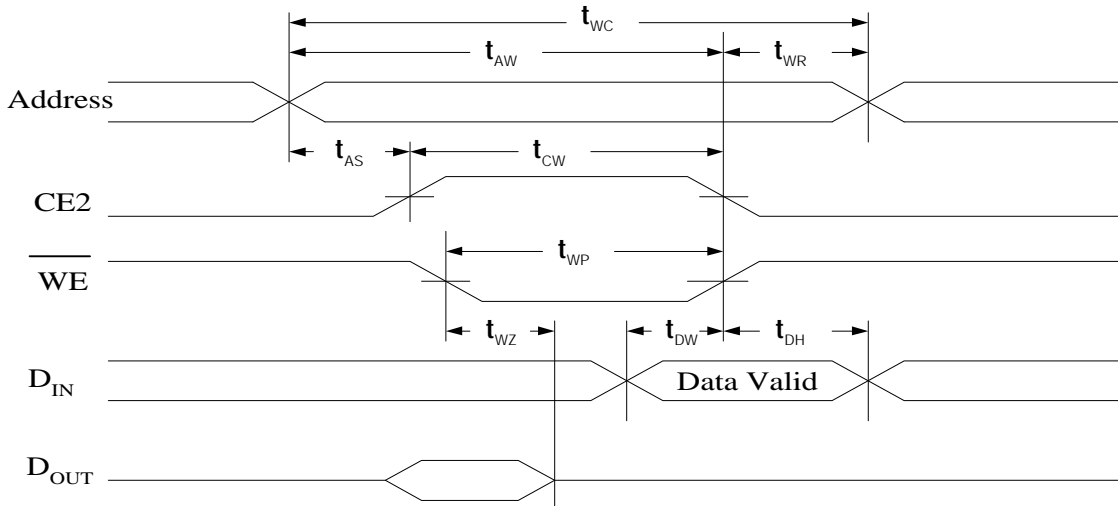
**Timing Waveform of Write Cycle 1 <sup>(10,11)</sup> ( $\overline{WE}$  Controlled)**



**Timing Waveform of Write Cycle 2 <sup>(10,11)</sup> ( $\overline{CE1}$  Controlled)**

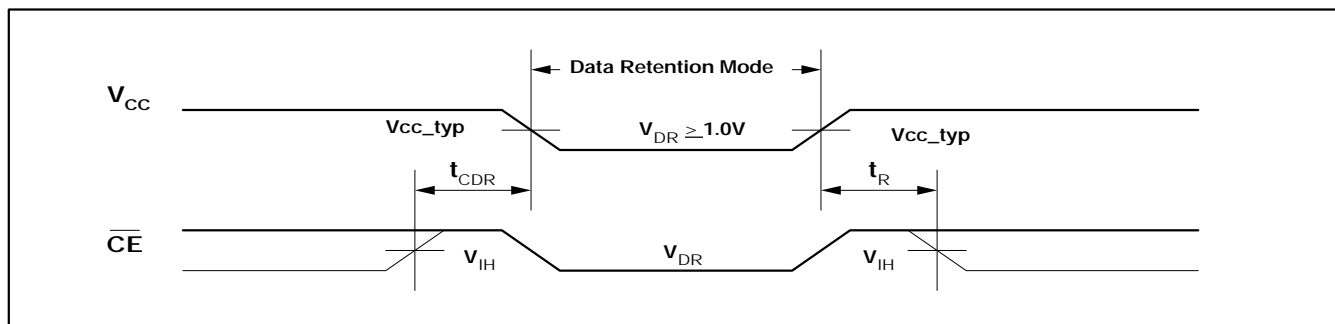


**Timing Waveform of Write Cycle 3 <sup>(10,11)</sup> (CE2 Controlled)**



**Data Retention Characteristics (L Version Only)<sup>(1)</sup>**

Parameter	Symbol	Test Condition	Min	Max	Unit
V <sub>CC</sub> for Data Retention	V <sub>DR</sub>	$\overline{CE}_1 \geq V_{CC} - 0.2V$ or	1.0	-	V
Data Retention Current	I <sub>CCDR</sub>	$CE_2 \leq +0.2V$		1	μA
Chip Deselect to Data Retention Time	t <sub>CDR</sub>	$V_{IN} \geq V_{CC} - 0.2V$ or	0	-	ns
Operation Recovery Time <sup>(2)</sup>	t <sub>R</sub>	$V_{IN} \leq 0.2V$	t <sub>RC</sub>	-	ns

**Data Retention Waveform (L Version Only) (T<sub>A</sub> = 0<sup>0</sup>C to +70<sup>0</sup>C / -40<sup>0</sup>C to +85<sup>0</sup>C)**

**Notes**

1. L-version includes this feature.
2. This Parameter is samples and not 100% tested.
3. For test conditions, see *AC Test Condition*, Figure A.
4. This parameter is tested with CL = 5pF as shown in Figure B. Transition is measured ± 500mV from steady-state voltage.
5. This parameter is guaranteed, but is not tested.
6.  $\overline{WE}$  is HIGH for read cycle.
7.  $\overline{CE1}$  and  $\overline{OE}$  are LOW and CE2 is HIGH for read cycle.
8. Address valid prior to or coincident with  $\overline{CE1}$  transition LOW or CE2 transition HIGH.
9. All read cycle timings are referenced from the last valid address to the first transition address.
10.  $\overline{CE1}$  or  $\overline{WE}$  must be HIGH or CE2 must be LOW during address transition.
11. All write cycle timings are referenced from the last valid address to the first transition address.

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**Ordering Information**

<b>Device Type*</b>	<b>Speed</b>	<b>Package</b>
V62C1802048L-70V	70 ns	8x13.4 mm 32-pin Plastic STSOP
V62C1802048L-85V	85 ns	
V62C1802048L-100V	100 ns	
V62C1802048L-150V	150 ns	
V62C1802048LL-70V	70 ns	
V62C1802048LL-85V	85 ns	
V62C1802048LL-100V	100 ns	
V62C1802048LL-150V	150 ns	
V62C1802048L-70T	70 ns	8 x 20 mm 32-pin Plastic TSOP1
V62C1802048L-85T	85 ns	
V62C1802048L-100T	100 ns	
V62C1802048L-150T	150 ns	
V62C1802048LL-70T	70 ns	
V62C1802048LL-85T	85 ns	
V62C1802048LL-100T	100 ns	
V62C1802048LL-150T	150 ns	

\* For Industrial Temperature tested devices, an "T" designator will be added to the end of the Device number.



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